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## THE LINE ED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of			
Hirozoh Tsuruta et al.	Group Art Unit: 3723		
Application No.: 10/540,480	Examiner:		
Filed: June 23, 2005	Confirmation No.: 2983		
For: SLURRY FOR CUTTING SILICON INGOT AND METHOD OF CUTTING SILICON INGOT USING THE SAME	) ) )		

## REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

Commissioner for Patents Office of Initial Patent Examination Customer Service Center P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Enclosed is a copy of the Official Filing Receipt marked in red to show correction that is needed. The correction is as follows:

## TITLE SHOULD READ:

SLURRY FOR <u>CUTTING</u> SILICON INGOT AND METHOD <u>OF CUTTING</u> SILICON INGOT USING THE SAME

Issuance of a corrected Official Filing Receipt is respectfully requested.

Respectfully submitted,

**BUCHANAN INGERSOLL PC** 

Date: <u>January 13, 2006</u>

By: <u>/a.</u>

James A. LaBarre

Registration No. 28,632

P.O. Box 1404 Alexandria, Virginia 22313-1404 (703) 836-6620





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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/540,480	06/23/2005	3723	900	025260-100	7	2	

**CONFIRMATION NO. 2983** 

21839 BUCHANAN INGERSOLL PC (INCLUDING BURNS, DOANE, SWECKER & MATHIS) POST OFFICE BOX 1404 ALEXANDRIA, VA 22313-1404

Date Mailed: 12/19/2005

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Hirozoh Tsuruta, Tokyo, JAPAN; Masayuki Hamayasu, Tokyo, JAPAN; Takafumi Kawasaki, Tokyo, JAPAN; Hirokazu Nishida, Tokyo, JAPAN; Hisashi Tominaga, Tokyo, JAPAN;

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Power of Attorney: The patent practitioners associated with Customer Number 21839.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/15030 10/12/2004

Foreign Applications

JAPAN 2003356750 10/16/2003

Projected Publication Date: 03/23/2006

Non-Publication Request: No

**Early Publication Request: No** 

Title

CUTTING

OF CUTTING

Slurry for slicing silicon ingot and method for slicing silicon ingot using same

**Preliminary Class** 

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